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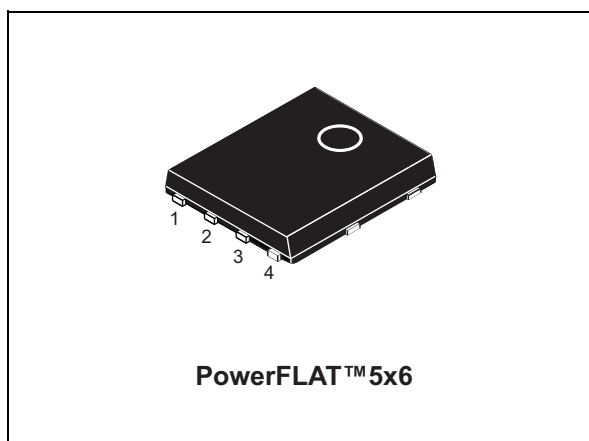
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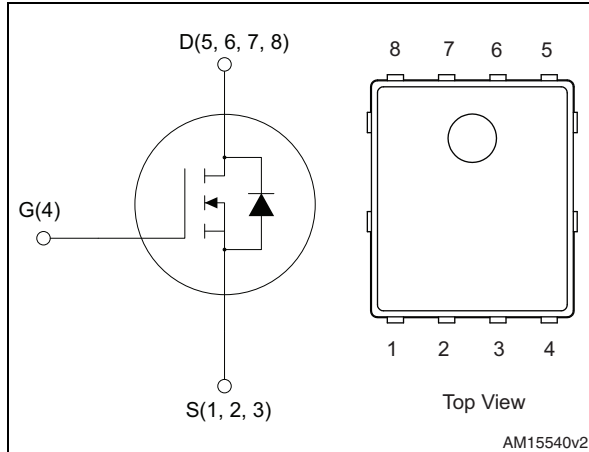
# STL110N10F7

## N-channel 100 V, 0.005 Ω typ., 107 A, STripFET™ H7 Power MOSFET in a PowerFLAT™ 5x6 package

Datasheet - production data



**Figure 1. Internal schematic diagram**



### Features

| Order code  | V <sub>DS</sub> | R <sub>DS(on)</sub> max             | I <sub>D</sub> | P <sub>TOT</sub> |
|-------------|-----------------|-------------------------------------|----------------|------------------|
| STL110N10F7 | 100 V           | 0.006 Ω<br>(V <sub>GS</sub> = 10 V) | 107 A          | 136 W            |

- Among the lowest R<sub>DS(on)</sub> on the market
- Excellent figure of merit (FoM)
- Low C<sub>rss</sub>/C<sub>iss</sub> ratio for EMI immunity
- High avalanche ruggedness

### Applications

- Switching applications

### Description

This N-channel Power MOSFET utilizes the STripFET™ H7 technology with a trench gate structure combined with extremely low on-resistance. The device also offers ultra-low capacitances for higher switching frequency operations.

**Table 1. Device summary**

| Order code  | Marking  | Package        | Packaging     |
|-------------|----------|----------------|---------------|
| STL110N10F7 | 110N10F7 | PowerFLAT™ 5x6 | Tape and reel |

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## Contents

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# 1 Electrical ratings

Table 2. Absolute maximum ratings

| Symbol             | Parameter  | Value      | Unit             |
|--------------------|--|------------|------------------|
| $V_{DS}$           | Drain-source voltage   | 100        | V                |
| $V_{GS}$           | Gate-source voltage  | $\pm 20$   | V                |
| $I_D^{(1)}$        | Drain current (continuous) at $T_C = 25\text{ }^\circ\text{C}$     | 107        | A                |
| $I_D^{(1)}$        | Drain current (continuous) at $T_C = 100\text{ }^\circ\text{C}$    | 75         | A                |
| $I_D^{(2)}$        | Drain current (continuous) at $T_{pcb} = 25\text{ }^\circ\text{C}$ | 21         | A                |
| $I_D^{(2)}$        | Drain current (continuous) at $T_{pcb}=100\text{ }^\circ\text{C}$  | 14         | A                |
| $I_{DM}^{(2)(3)}$  | Drain current (pulsed)   | 84         | A                |
| $P_{TOT}^{(1)}$    | Total dissipation at $T_C = 25\text{ }^\circ\text{C}$              | 136        | W                |
| $P_{TOT}^{(2)}$    | Total dissipation at $T_{pcb} = 25\text{ }^\circ\text{C}$          | 4.8        | W                |
| $E_{AS}^{(4)}$     | Single pulse avalanche energy                                      | 490        | mJ               |
| $T_J$<br>$T_{stg}$ | Operating junction temperature<br>Storage temperature              | -55 to 175 | $^\circ\text{C}$ |

1. This value is rated according to  $R_{thj-c}$ .
2. This value is rated according to  $R_{thj-pcb}$ .
3. Pulse width limited by safe operating area.
4. Starting  $T_j=25\text{ }^\circ\text{C}$ ,  $I_d=18\text{ A}$ ,  $V_{dd}=50\text{ V}$

Table 3. Thermal resistance

| Symbol              | Parameter                        | Value | Unit               |
|---------------------|----------------------------------|-------|--------------------|
| $R_{thj-case}$      | Thermal resistance junction-case | 1.1   | $^\circ\text{C/W}$ |
| $R_{thj-pcb}^{(1)}$ | Thermal resistance junction-pcb  | 31.3  | $^\circ\text{C/W}$ |

1. When mounted on FR-4 board of 1inch<sup>2</sup>, 2oz Cu,  $t < 10\text{ sec}$

Electrical characteristics

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## 2 Electrical characteristics

(T<sub>CASE</sub>=25 °C unless otherwise specified)

Table 4. On/off states

| Symbol               | Parameter                         | Test conditions  | Min. | Typ.  | Max.  | Unit |
|----------------------|-----------------------------------|--|------|-------|-------|------|
| V <sub>(BR)DSS</sub> | Drain-source breakdown voltage    | V <sub>GS</sub> = 0, I <sub>D</sub> = 250 μA                         | 100  |       |       | V    |
| I <sub>DSS</sub>     | Zero gate voltage drain current   | V <sub>GS</sub> = 0, V <sub>DS</sub> = 100 V                         |      |       | 1     | μA   |
|                      |                                   | V <sub>GS</sub> = 0, V <sub>DS</sub> = 100 V, T <sub>C</sub> =125 °C |      |       | 10    | μA   |
| I <sub>GSS</sub>     | Gate body leakage current         | V <sub>DS</sub> = 0, V <sub>GS</sub> = 20 V                          |      |       | 100   | nA   |
| V <sub>GS(th)</sub>  | Gate threshold voltage            | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA          | 2.5  |       | 4.5   | V    |
| R <sub>DS(on)</sub>  | Static drain-source on-resistance | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A                        |      | 0.005 | 0.006 | Ω    |

Table 5. Dynamic

| Symbol           | Parameter                    | Test conditions  | Min. | Typ. | Max. | Unit |
|------------------|------------------------------|--|------|------|------|------|
| C <sub>iss</sub> | Input capacitance            | V <sub>DS</sub> = 50 V, f=1 MHz, V <sub>GS</sub> =0  | -    | 5117 | -    | pF   |
| C <sub>oss</sub> | Output capacitance           |  | -    | 992  | -    | pF   |
| C <sub>rss</sub> | Reverse transfer capacitance |  | -    | 39   | -    | pF   |
| Q <sub>g</sub>   | Total gate charge            | V <sub>DD</sub> = 50 V, I <sub>D</sub> = 21 A<br>V <sub>GS</sub> =10 V<br><i>Figure 14</i> | -    | 72   | -    | nC   |
| Q <sub>gs</sub>  | Gate-source charge           |  | -    | 30   | -    | nC   |
| Q <sub>gd</sub>  | Gate-drain charge            |  | -    | 17   | -    | nC   |

Table 6. Switching times

| Symbol              | Parameter           | Test conditions  | Min. | Typ. | Max. | Unit |
|---------------------|---------------------|--|------|------|------|------|
| t <sub>d(on)</sub>  | Turn-on delay time  | V <sub>DD</sub> =50 V, I <sub>D</sub> = 10 A,<br>R <sub>G</sub> =4.7 Ω, V <sub>GS</sub> = 10 V<br><i>Figure 13</i> | -    | 25   | -    | ns   |
| t <sub>r</sub>      | Rise time           |  | -    | 36   | -    | ns   |
| t <sub>d(off)</sub> | Turn-off delay time |  | -    | 52   | -    | ns   |
| t <sub>f</sub>      | Fall time           |  | -    | 21   | -    | ns   |

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**Electrical characteristics**

**Table 7. Source drain diode**

| Symbol          | Parameter                     | Test conditions   | Min. | Typ. | Max. | Unit |
|-----------------|-------------------------------|---|------|------|------|------|
| $I_{SD}$        | Source-drain current          |   | -    |      | 21   | A    |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) |   | -    |      | 84   | A    |
| $V_{SD}^{(2)}$  | Forward on voltage            | $V_{GS}=0, I_{SD} = 21 \text{ A}$   | -    |      | 1.2  | V    |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 21 \text{ A},$<br>$di/dt = 100 \text{ A}/\mu\text{s},$<br>$V_{DD}=80 \text{ V}, T_j=150 \text{ }^\circ\text{C}$ | -    | 77   |      | ns   |
| $Q_{rr}$        | Reverse recovery charge       |   | -    | 150  |      | nC   |
| $I_{RRM}$       | Reverse recovery current      |   | -    | 4.3  |      | A    |

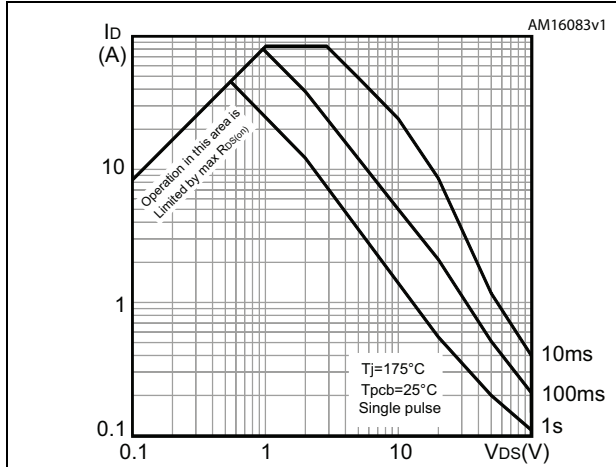
1. Pulse width limited by safe operating area
2. Pulsed: pulse duration=300  $\mu\text{s}$ , duty cycle 1.5%

**Electrical characteristics**

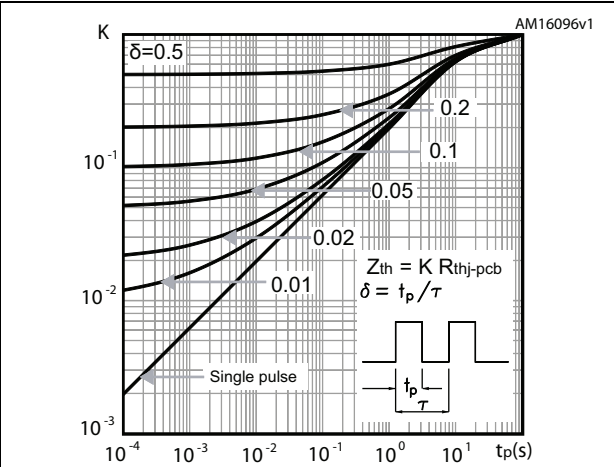
**STL110N10F7**

**2.1 Electrical characteristics (curves)**

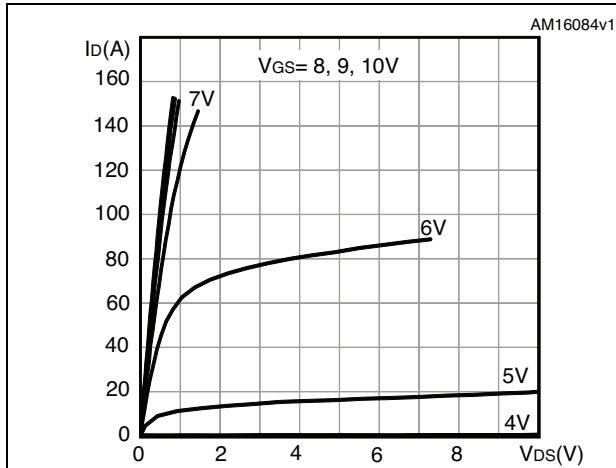
**Figure 2. Safe operating area**



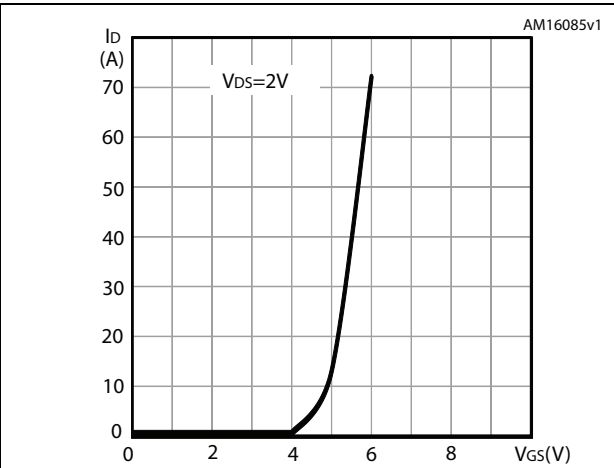
**Figure 3. Thermal impedance**



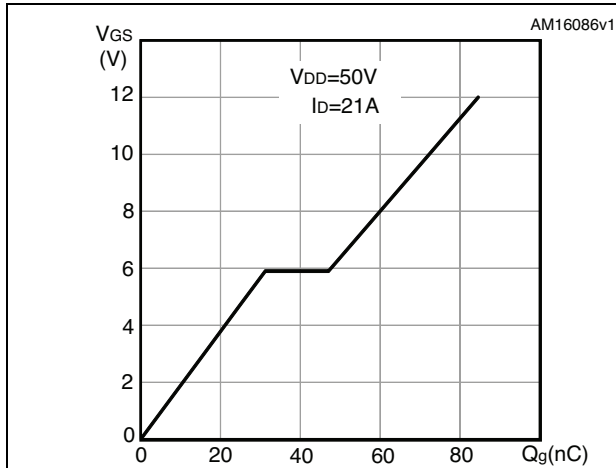
**Figure 4. Output characteristics**



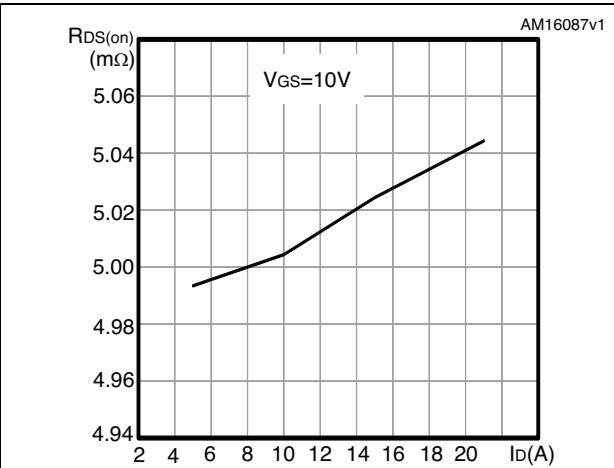
**Figure 5. Transfer characteristics**



**Figure 6. Gate charge vs gate-source voltage**



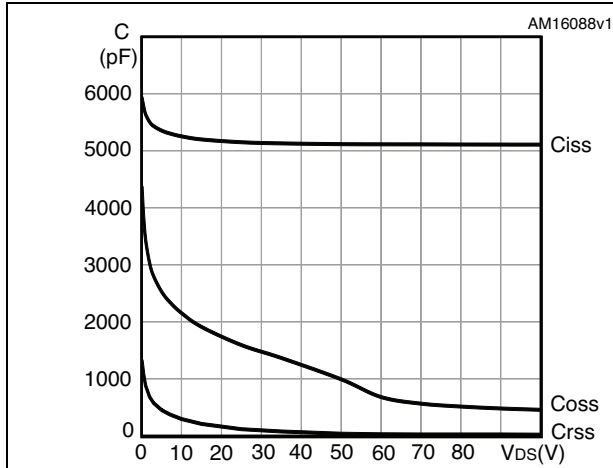
**Figure 7. Static drain-source on-resistance**



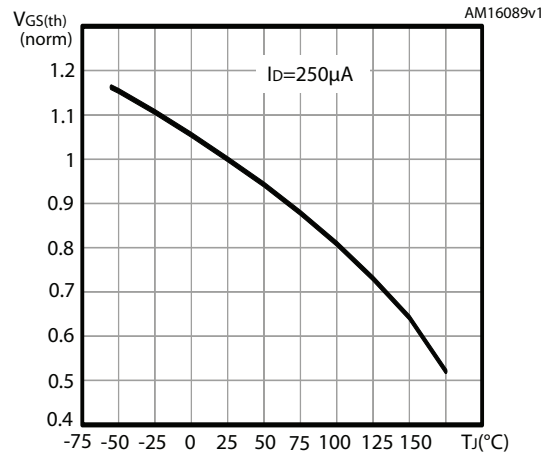
**STL110N10F7**

**Electrical characteristics**

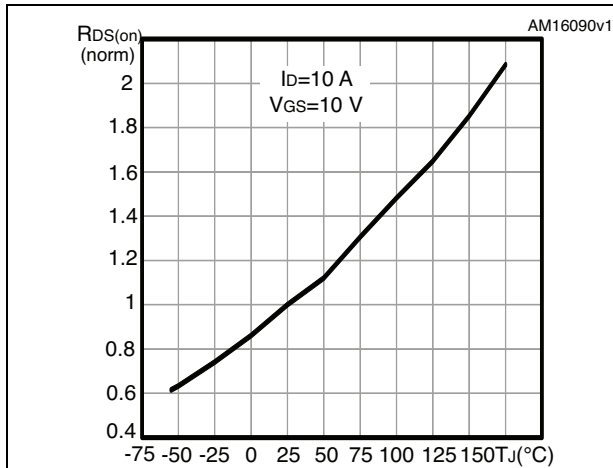
**Figure 8. Capacitance variations**



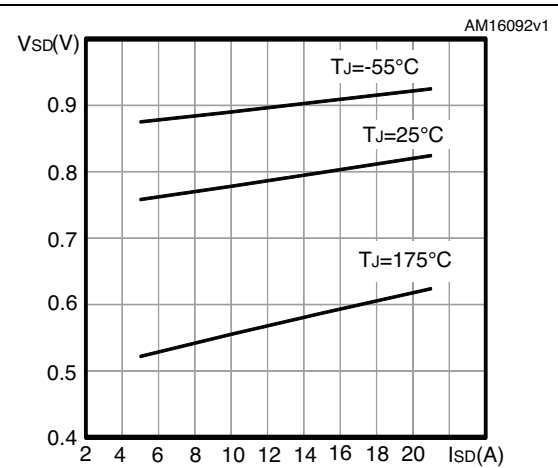
**Figure 9. Normalized gate threshold voltage vs temperature**



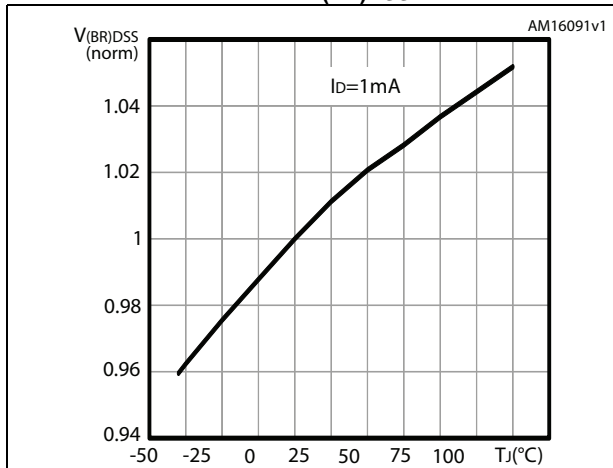
**Figure 10. Normalized on-resistance vs temperature**



**Figure 11. Source-drain diode forward characteristics**



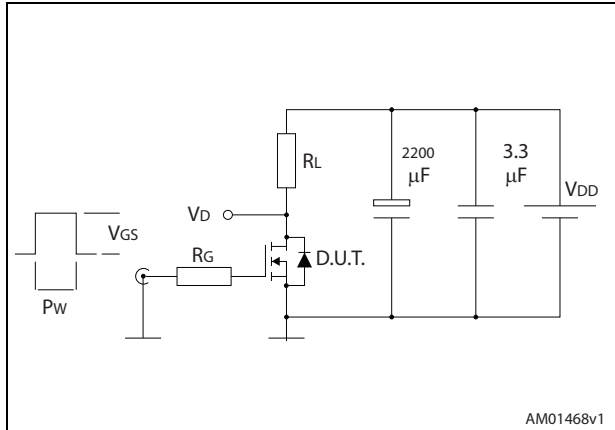
**Figure 12. Normalized V(BR)DSS vs temperature**



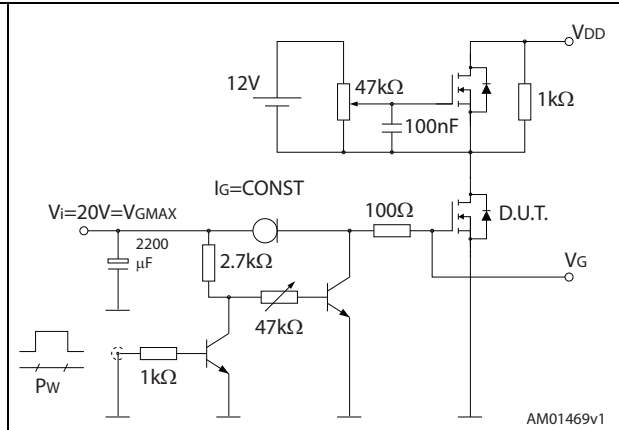


### 3 Test circuits

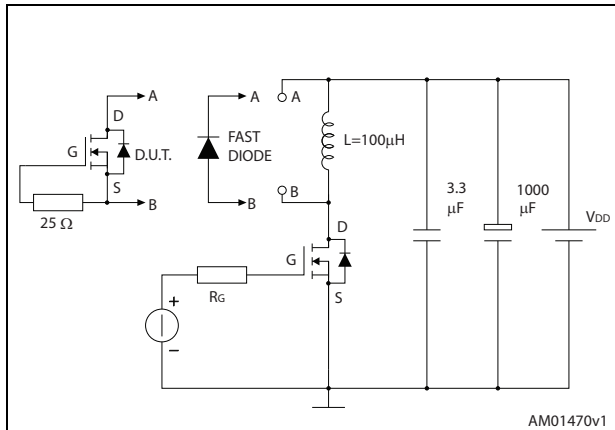
**Figure 13. Switching times test circuit for resistive load**



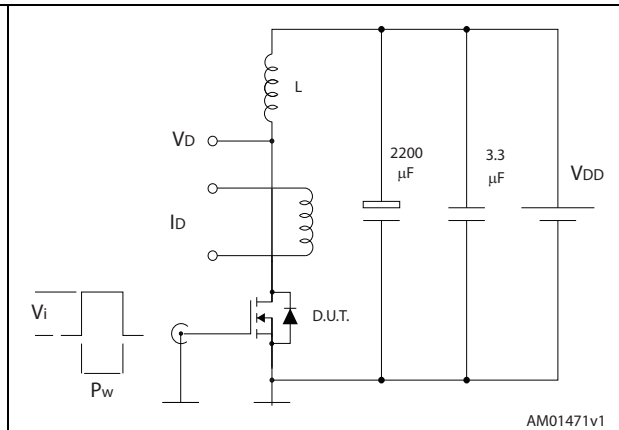
**Figure 14. Gate charge test circuit**



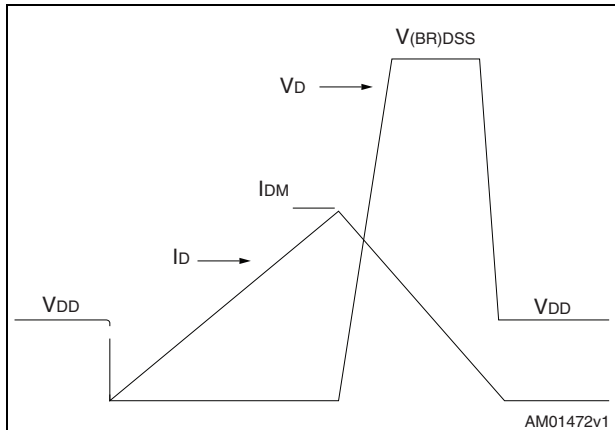
**Figure 15. Test circuit for inductive load switching and diode recovery times**



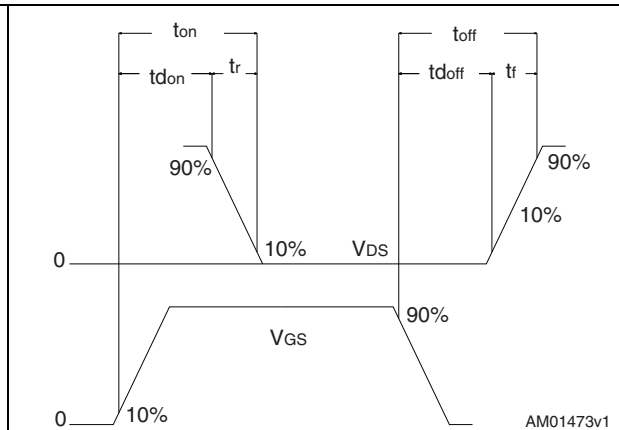
**Figure 16. Unclamped inductive load test circuit**



**Figure 17. Unclamped inductive waveform**



**Figure 18. Switching time waveform**



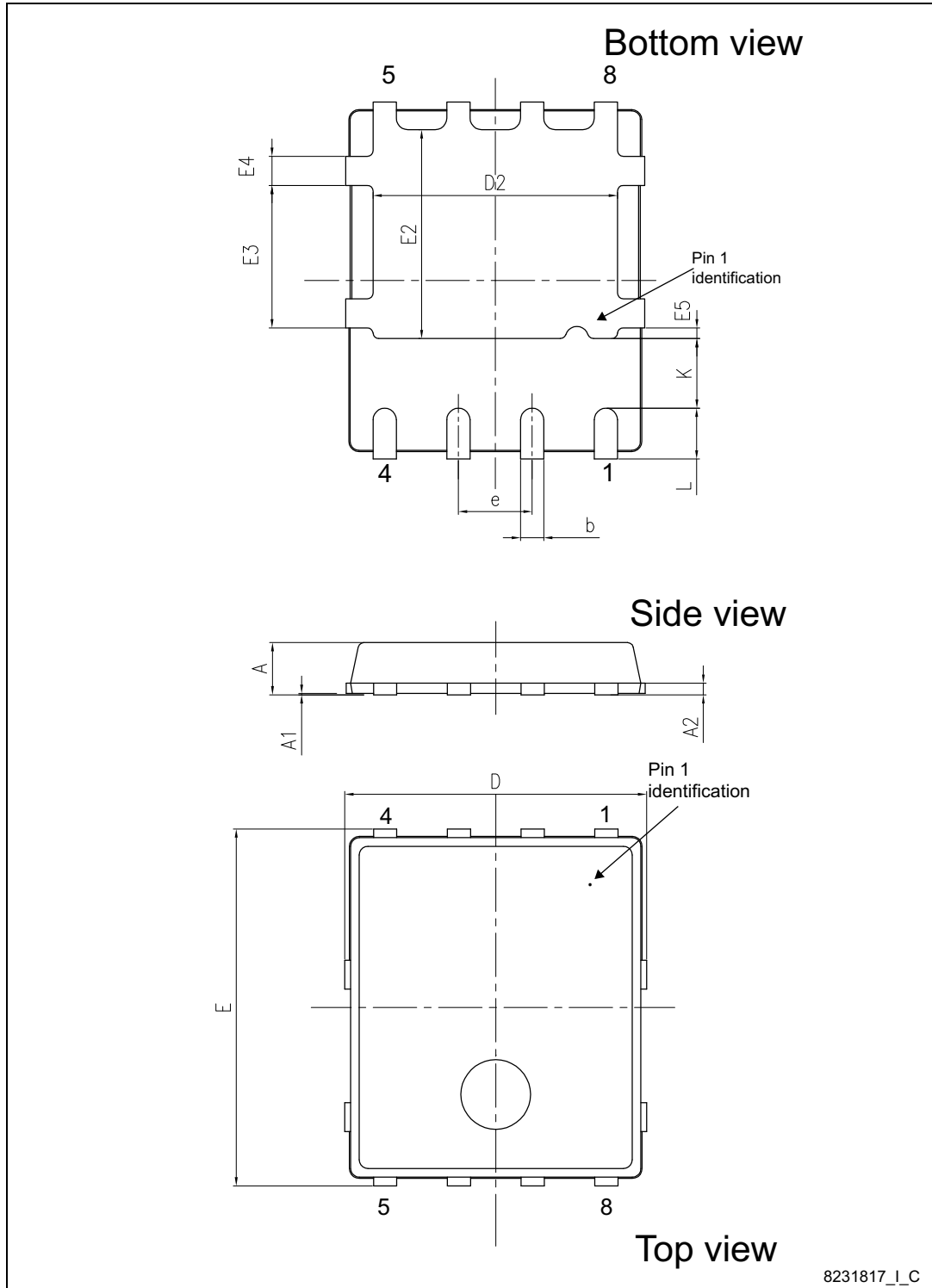
## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK<sup>®</sup> is an ST trademark.

**Package mechanical data**

**STL110N10F7**

**Figure 19. PowerFLAT™ 5x6 type S-C mechanical data**



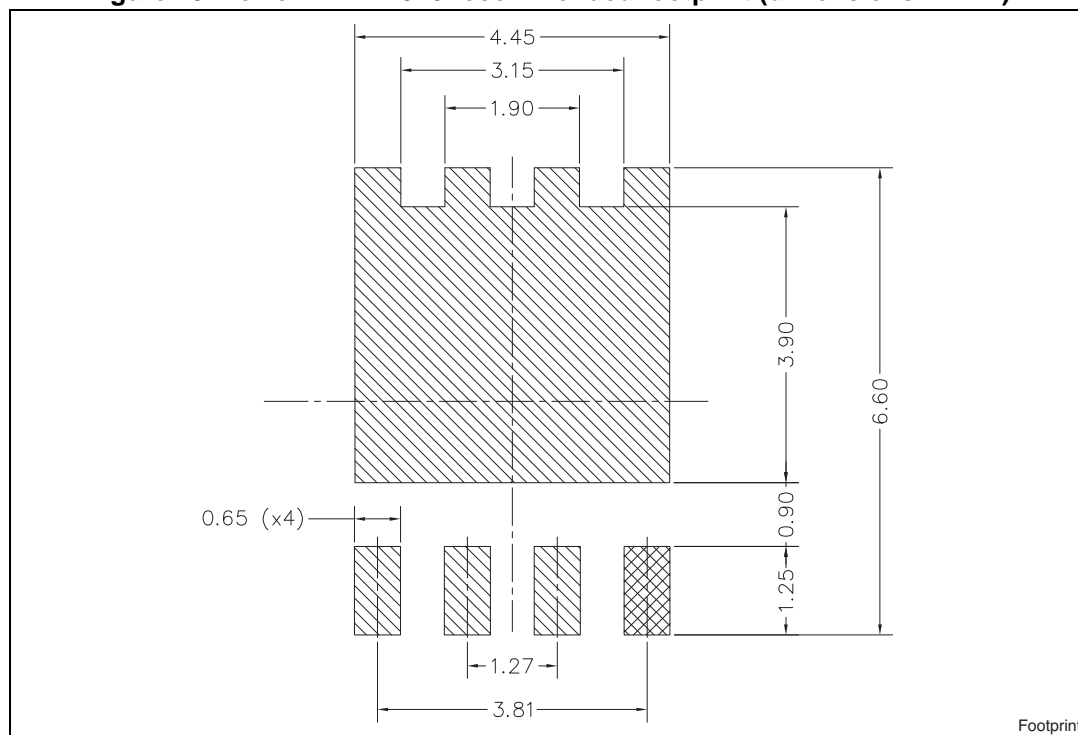
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**Package mechanical data**

**Table 8. PowerFLAT™ 5x6 type S-C mechanical data**

| Dim. | mm    |      |       |
|------|-------|------|-------|
|      | Min.  | Typ. | Max.  |
| A    | 0.80  |      | 1.00  |
| A1   | 0.02  |      | 0.05  |
| A2   |       | 0.25 |       |
| b    | 0.30  |      | 0.50  |
| D    |       | 5.20 |       |
| D2   | 4.11  |      | 4.31  |
| E    |       | 6.15 |       |
| e    |       | 1.27 |       |
| e1   |       | 0.65 |       |
| E2   | 3.50  |      | 3.70  |
| E3   | 2.35  |      | 2.55  |
| E4   | 0.40  |      | 0.60  |
| E5   | 0.08  |      | 0.28  |
| K    | 1.05  |      | 1.35  |
| L    | 0.715 |      | 1.015 |

**Figure 20. PowerFLAT™ 5x6 recommended footprint (dimensions in mm)**



## 5 Packaging mechanical data

Figure 21. PowerFLAT™ 5x6 tape<sup>(a)</sup>

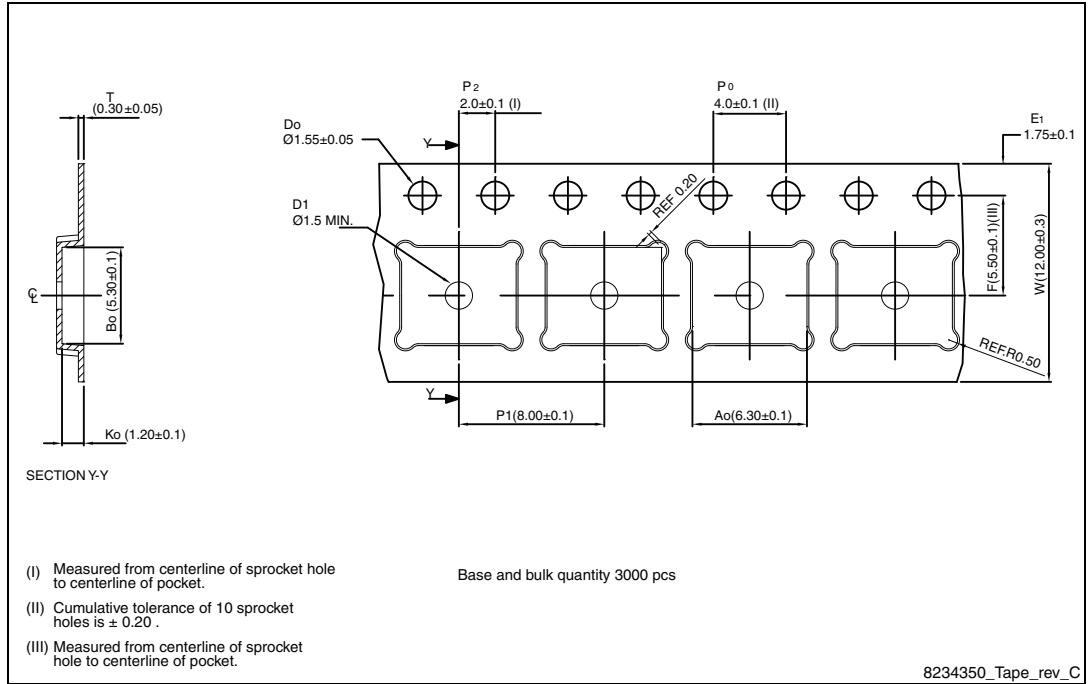
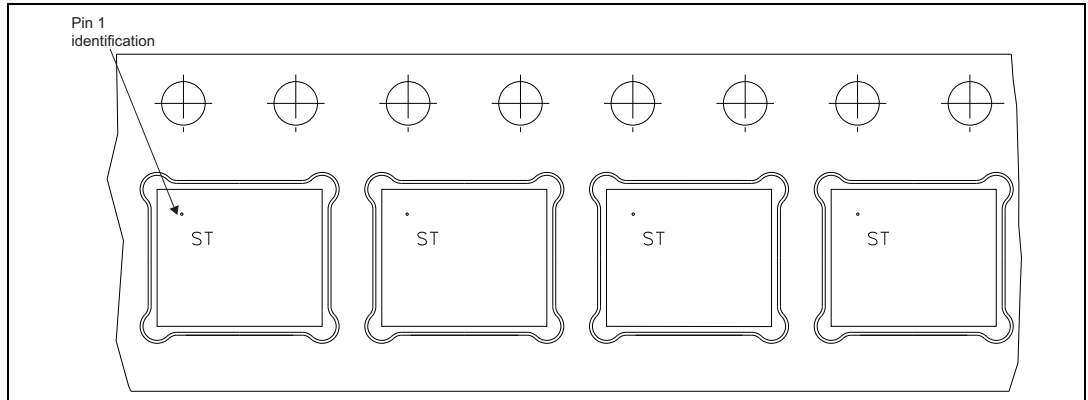


Figure 22. PowerFLAT™ 5x6 package orientation in carrier tape

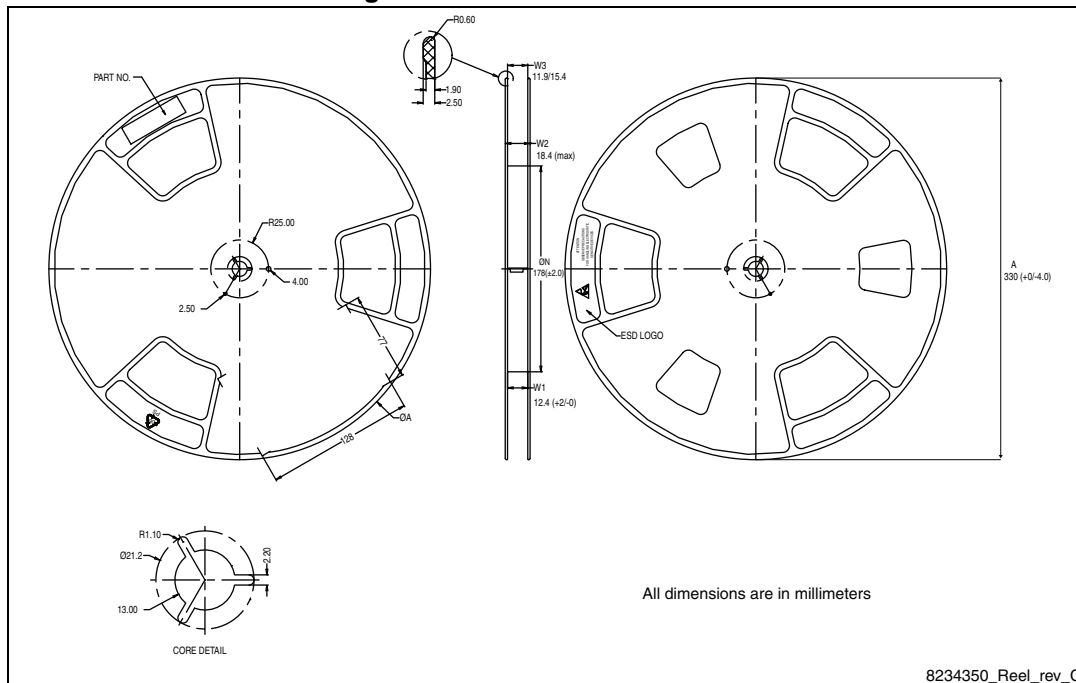


a. All dimensions are in millimeters.

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**Packaging mechanical data**

**Figure 23. PowerFLAT™ 5x6 reel**



## 6 Revision history

**Table 9. Document revision history**

| Date        | Revision | Changes   |
|-------------|----------|---|
| 03-Dec-2012 | 1        | First release.  |
| 12-Dec-2013 | 2        | <ul style="list-style-type: none"> <li>– Modified: <math>P_{TOT}</math> value and <i>Figure 1</i> in cover page</li> <li>– Modified: <math>I_D</math>, <math>I_{DM}</math> and <math>P_{TOT}</math> values in <i>Table 2</i></li> <li>– Added: <math>E_{AS}</math> value in <i>Table 2</i></li> <li>– Modified: all values in <i>Table 3</i></li> <li>– Modified: <math>I_{DSS}</math>, <math>I_{GSS}</math> and <math>I_D</math> for <math>R_{DS(on)}</math></li> <li>– Updated: the entire typical values in <i>Table 5, 6</i> and <i>7</i></li> <li>– Updated: <i>Figure 13, 14, 15</i> and <i>16</i></li> <li>– Minor text changes</li> </ul> |
| 25-Mar-2014 | 3        | <ul style="list-style-type: none"> <li>– Updated title and features on cover page.</li> <li>– Added <math>P_{TOT}</math> value at <math>T_C = 25\text{ °C}</math> in <i>Table 2: Absolute maximum ratings</i>.</li> <li>– Updated <i>Section 4: Package mechanical data</i>.</li> </ul>   |
| 20-Aug-2014 | 4        | <ul style="list-style-type: none"> <li>– Modified: title, features and description</li> <li>– Modified: <i>Figure 2</i> and <i>3</i></li> <li>– Updated: <i>Section 4: Package mechanical data</i></li> <li>– Minor text changes</li> </ul>   |

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